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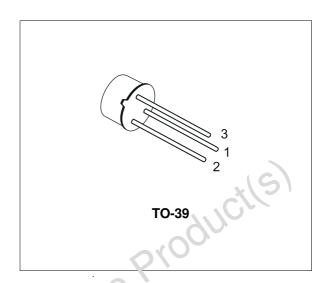


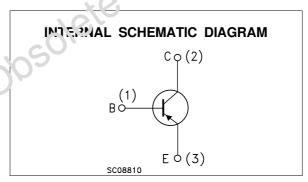
# SILICON PNP TRANSISTOR

- STMicroelectronics PREFERRED SALESTYPE
- PNP TRANSISTOR

### **DESCRIPTION**

The BSS44 is a silicon epitaxial planar PNP transistor in Jedec TO-39 metal case. It is used for high-current switching and power applications up to 5 A.





# ARSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value		
V <sub>CBO</sub>	Collector-Base Voltage (I <sub>E</sub> = 0)	- 65	V	
V <sub>CEO</sub>	Collector-Emitter Voltage (I <sub>B</sub> = 0)	- 60	V	
V <sub>EBO</sub>	Emitter-Base Voltage (I <sub>C</sub> = 0)	- 6	V	
Ic	Collector Current	- 5	Α	
P <sub>tot</sub>	Total Dissipation at T <sub>case</sub> ≤ 25 °C T <sub>amb</sub> ≤ 25 °C	5 0.87	W W	
T <sub>stg</sub>	Storage Temperature	-65 to 200	°C	
Tj	Max. Operating Junction Temperature	200	°C	

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## THERMAL DATA

R <sub>thj-case</sub>	Thermal Resistance Junction-case	Max	35	°C/W
R <sub>thj-amb</sub>	Thermal Resistance Junction-amb	Max	200	°C/W

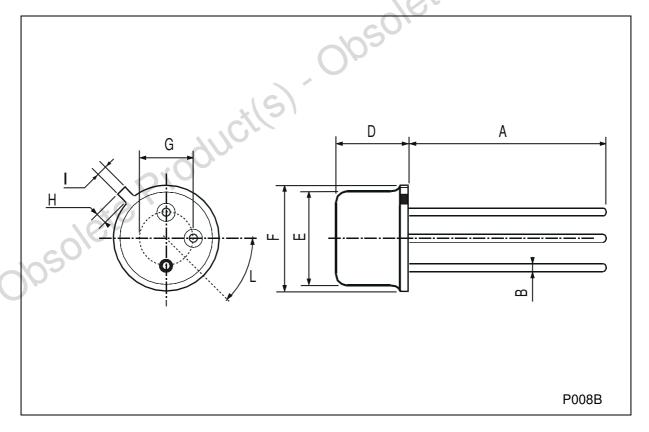
## **ELECTRICAL CHARACTERISTICS** (T<sub>case</sub> = 25 °C unless otherwise specified)

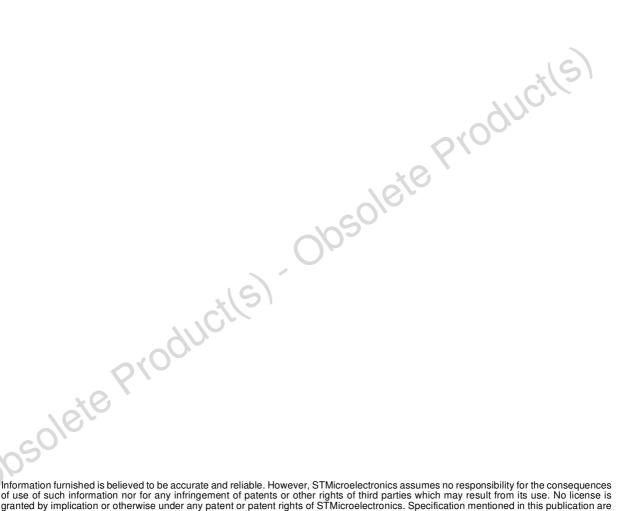
Symbol	Parameter	Test Cond	itions	Min.	Тур.	Max.	Unit
I <sub>CES</sub>	Collector Cut-off Current (V <sub>BE</sub> =0)	V <sub>CE</sub> = -60 V				-0.5	μА
V <sub>(BR)CBO</sub> *	Collector-base Breakdown Voltage (I <sub>E</sub> = 0)	$I_C = -1 \text{ mA}$		-65			V
$V_{CEO(sus)}^*$	Collector-Emitter Sustaining Voltage (I <sub>B</sub> = 0)	$I_C = -50 \text{ mA}$		-60			V
$V_{EBO}^*$	Emitter-base Voltage (I <sub>C</sub> = 0)	I <sub>E</sub> = 1 mA		-6			V
V <sub>CE(sat)</sub> *	Collector-Emitter Saturation Voltage	I <sub>C</sub> = -0.5 A I <sub>C</sub> = -5 A	$I_B = -50 \text{ mA}$ $I_B = -0.5 \text{ A}$		-0.1 -0.4	-1	) V
V <sub>BE(sat)</sub> *	Base-Emitter Saturation Voltage	I <sub>C</sub> = -0.5 A I <sub>C</sub> = -5 A	$I_B = -50 \text{ mA}$ $I_B = -0.5 \text{ A}$		-0.8 -1.1	-1.6	V V
h <sub>FE</sub> *	DC Current Gain	I <sub>C</sub> = -0.5 A I <sub>C</sub> = -2 A I <sub>C</sub> = -5 A	V <sub>CE</sub> = -2 V V <sub>CE</sub> = -2 V V <sub>CE</sub> = -2 V	30 40	70 45		
$f_T^*$	Transition Frequency	$I_C = -0.5 A$	$V_{CE} = -5 V$		80		MHz
Ссво	Collector-base Capacitance	I <sub>E</sub> = 0 f = 1 MHz	$V_{CB} = 10 \text{ V}$			100	pF
ton	Turn-on Time	IC = -0.5 A	$V_{CC} = -20 \text{ V}$		0.065		μs
t <sub>off</sub>	Turn-off Time	$I_{B1} = -I_{B2} = -50 \text{ mA}$			0.45		μs
	Turn-off Time se duration = 300 μs, duty cycle 1	cilsi					

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# **TO-39 MECHANICAL DATA**

DIM.	mm			inch			
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	12.7			0.500			
В			0.49			0.019	
D			6.6			0.260	
E			8.5			0.334	
F			9.4			0.370	
G	5.08			0.200		*(5)	
Н			1.2		Al	0.047	
I			0.9		0100	0.035	
L			45° (	(typ.)			





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